

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4941772

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YOU WU	04/20/2018
WAI CHUNG PETER WONG	04/20/2018
CHEUK NANG DANIEL SUNG	04/20/2018
SHUN HUNG KIANG	04/20/2018
KAM FAI CARY WONG	04/20/2018
TSZ KIN YU	04/20/2018
RECEIVING PARTY DATA	
Name:	KA SHUI PLASTIC TECHNOLOGY COMPANY LIMITED
Street Address:	FLAT/RM A, 29/F, TOWER B BILLION CENTRE, 1 WANG KWONG ROAD,
City:	KOWLOONG BAY
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15968731
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	ZHIHUA HAN
SIGNATURE:	/Zihua Han/
DATE SIGNED:	05/01/2018
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial Number
Filing Date
Inventorship Wu et al.
Attorney's Docket No. LiAron_0003US
Title: METHOD FOR PREPARING MODIFIED THERMOPLASTICS HAVING GERM-
REPELLENT PROPERTIES AND A PRODUCT THEREOF, AND A COMPOSITION FOR
PREPARING THE MODIFIED THERMOPLASTICS

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

WU You

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Assignee:

Ka Shui Plastic Technology Company Limited

Flat/Rm A, 29/F, Tower B Billion Centre, 1 Wang Kwong Road, Kowloong Bay, Hong Kong

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled
"METHOD FOR PREPARING MODIFIED THERMOPLASTICS HAVING GERM-REPELLENT
PROPERTIES AND A PRODUCT THEREOF, AND A COMPOSITION FOR PREPARING
THE MODIFIED THERMOPLASTICS" for which:

a provisional application for United States Letters Patent was filed on _____ and was given U.S. Serial No. _____ and/or

X a non-provisional application for United States Letters Patent was:


filed on _____ and was given U.S. Serial No. _____; or filed concurrently herewith. Assignors hereby authorize and request ASSIGNEE's legal representatives, of WEN IP LLC, 7710 80th PL SE, Mercer Island, WA 98040, who are associated with customer number **154422**, to insert in the caption above the serial number and filing date of the patent application when known.

WHEREAS, Ka Shui Plastic Technology Company Limited (hereinafter referred to as ASSIGNEE), a corporation of Hong Kong having a place of business at Flat/Rm A, 29/F, Tower B Billion Centre, 1 Wang Kwong Road, Kowloong Bay, Hong Kong, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention

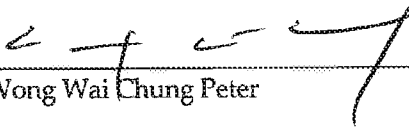
to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

20-4-2018
Date




WU You

20-4-2018
Date



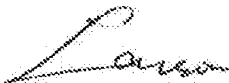
Wong Wai Chung Peter

20-04-2018
Date



Sung Cheuk Nang Daniel

20-04-2018
Date



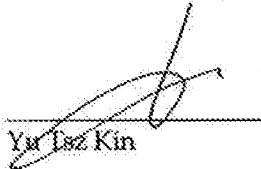
Kiang Shun Hung

20-04-2018
Date



Wong Kam Fai Cary

20-4-2018
Date



Yu Tsz Kin